

Description

45V N-CHANNEL ENHANCEMENT MODE POWER MOSFET

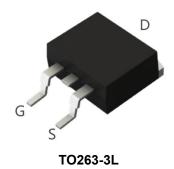
Features

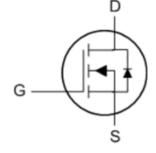
- Device Rating V_{DS} = 45V, I_D = 251A
- $R_{DS(ON)}$ =1.3m Ω (typ.) @ V_{GS} = 10V, I_D = 20A
- $R_{DS(ON)} = 1.7 \text{m}\Omega$ (typ.) @ $V_{GS} = 4.5 \text{V}$, $I_D = 10 \text{A}$
- Proprietary High Density Trench Technology
- RoHS Compliant & Halogen-Free

Application For Consumer

- BLDC
- BMS

Package





JFG251N45E

Absolute Maximum Ratings T_C=25℃ unless otherwise specified

Symbol	Parameter		Max.	Units
V _{DS}	Drain-Source Voltage		45	V
V _{GS}	Gate-Source Voltage		± 20	V
ID	Continuous Drain Current, VGS @ 10V note1	T _C = 25°C	251	А
		T _C = 100°C	159	А
I _{DM}	Pulsed Drain Current note2		1004	А
P _D	Power Dissipation note4	T _C = 25°C	158	W
	Power Dissipation	T _A = 25℃	7.81	W
Eas	Single Pulsed Avalanche Energy note3		454	mJ
Rejc	Thermal Resistance, Junction to Case note1		0.79	°C/W
R _θ JA	Junction-to-Ambient (mounted on 1 inch square PCB)		16	°C/W
TJ, TSTG	Operating and Storage Temperature Range		-55 to +150	$^{\circ}$ C



Electrical Characteristics Tc=25℃ unless otherwise specified

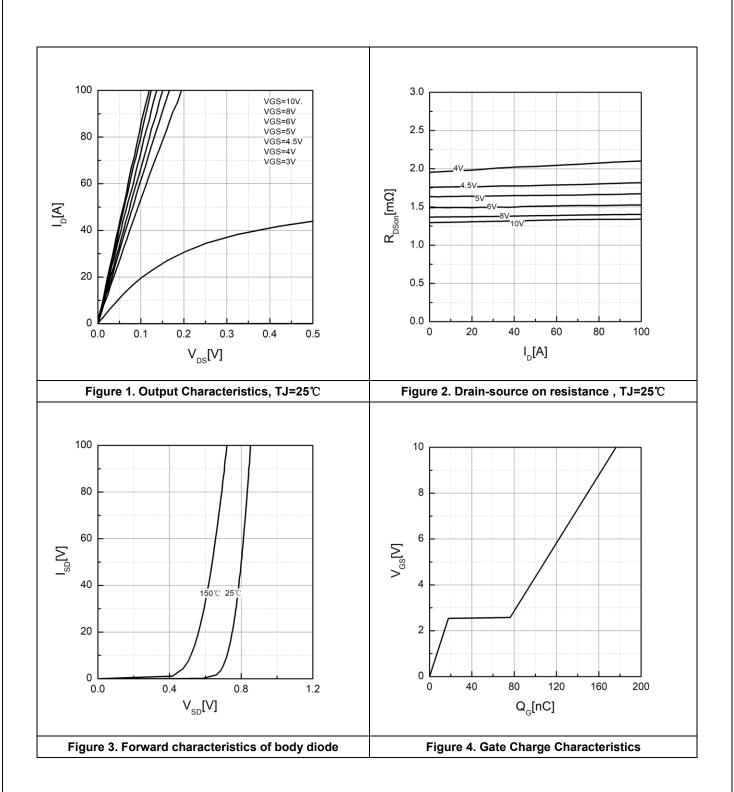
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	45	-	-	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} = 45V, V _{GS} = 0V	-	-	1	μA
		V _{DS} = 45V, V _{GS} = 0V ,T _C = 55°C	-	-	10	μA
Igss	Gate-Source Leakage Current	V _{DS} = 0V, V _{GS} = ±20V	-100	-	100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	1.0	-	2.5	V
Б.	Static Drain-Source On-	V _{GS} = 10V, I _D =20A	-	1.3	1.6	mΩ
R _{DS(on)}	Resistance note2	V _{GS} = 4.5V, I _D =20A	-	1.7	2.1	mΩ
g FS	Forward Transconductance	V _{DS} = 10V, I _D =20A		69	_	S
Dynamic C	Characteristics	I.		ı		
Rg	Gate Resistance		-	1.3	-	Ω
Ciss	Input Capacitance		-	7160	-	pF
Coss	Output Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$	-	1130	-	pF
Crss	Reverse Transfer Capacitance	f = 1.0MHz	-	1080	-	pF
Qg	Total Gate Charge	V _{DS} =20V, I _D = 20A,	-	176	-	nC
Qgs	Gate-Source Charge		-	17.8	-	nC
Q _{gd}	Gate-Drain("Miller") Charge	- V _{GS} = 10V	-	58.4	-	nC
Switching	Characteristics		•	•		
t _{d(on)}	Turn-On Delay Time		_	32	-	ns
tr	Turn-On Rise Time	$V_{DD} = 20V, I_D = 20A,$	_	96	-	ns
t _{d(off)}	Turn-Off Delay Time	$R_{G} = 8\Omega, V_{GS} = 10V$	-	108	-	ns
t _f	Turn-Off Fall Time	-	-	68	-	ns
Drain-Sou	rce Diode Characteristics and Maxi	mum Ratings	1	1		I
Is	Maximum Continuous Diode Forward Current note1,5		-	_	131	Α
Ism	Maximum Pulsed Diode Forward C	urrent note2,5	-	-	1004	Α
t _{rr}	Reverse Recovery Time	T _J = 25°C, I _S = 20A,		0.5		
		V _{GS} = 0V	- 65		-	ns
Qrr	Reverse Recovery Charge	T _J = 25°C, I _S = 20A,		00		0
		di/dt = 150A/μs		32		nC
V _{SD} note2	Drain to Source Diode Forward	T _J = 25°C, I _S = 20A,	-	0.72	-	V
	Voltage	V _{GS} = 0V				

Note:

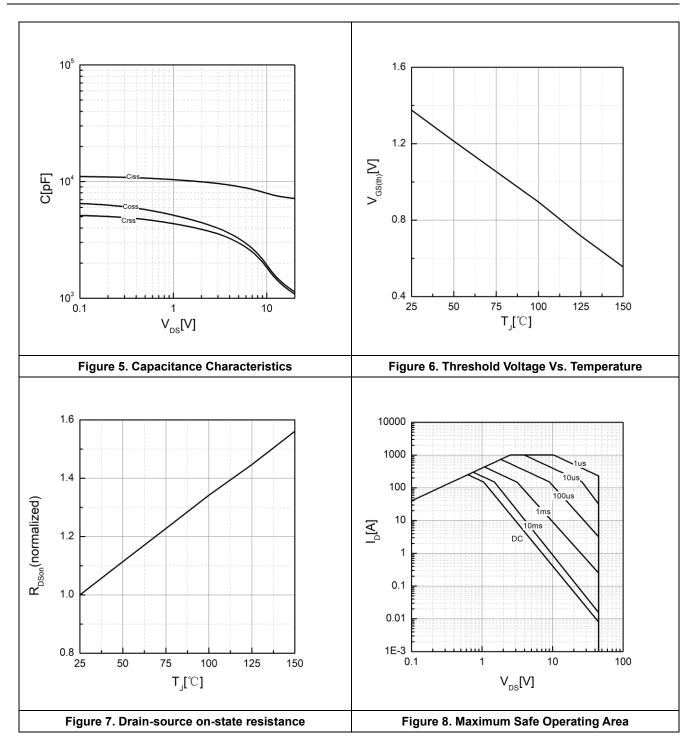
- 1.The data tested by surface mounted on one inch² FR-4 board with 2OZ copper.
- 2. The data tested by pulsed, pulse width \leq 300us, duty cycle \leq 2%.
- 3. The EAS data shows Max. rating. The test condition is VDD=40V, VGS=10V, L=0.1mH, IAS=95.2A.
- 4.The power dissipation is limited by 150°C junction temperature.
- 5.The data is theoretically the same as l_D and l_{DM} , in real applications, should be limited by total power dissipation.



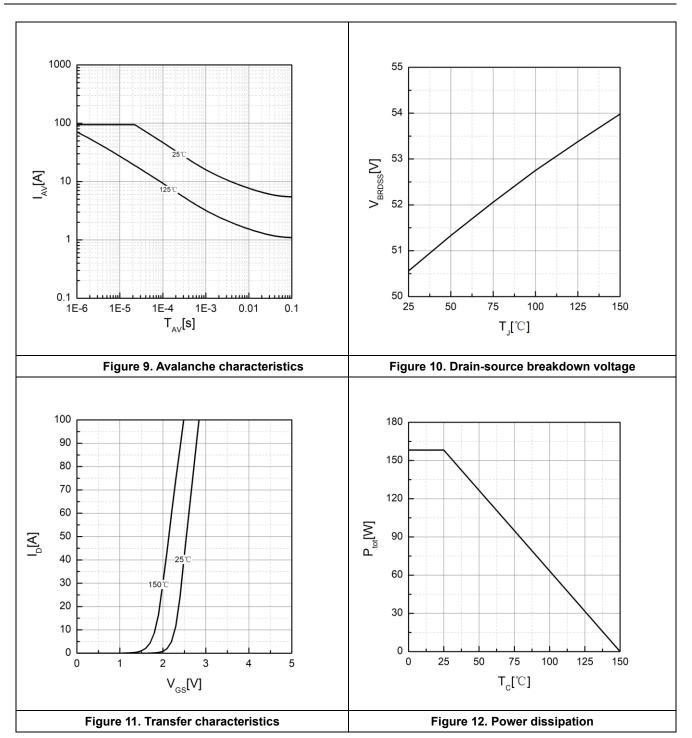
Typical Performance Characteristics













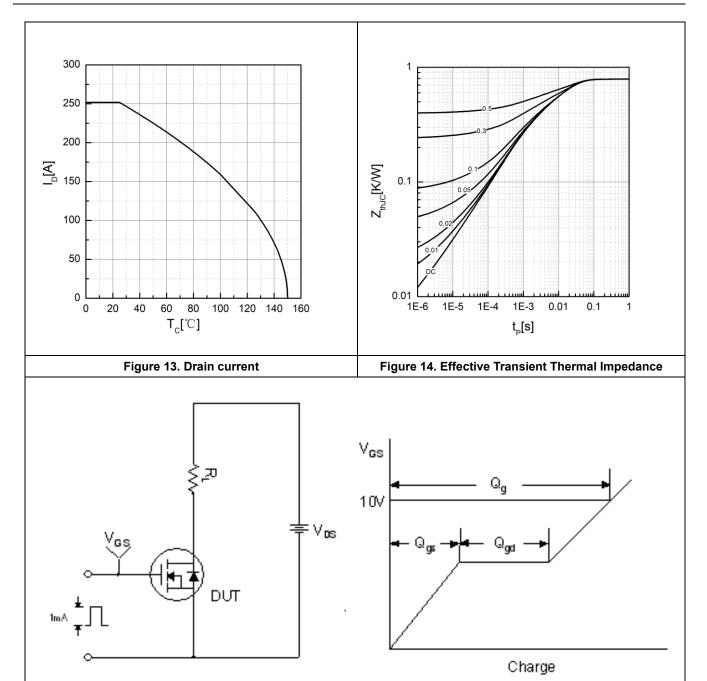


Figure 15. Gate Charge Test Circuit & Waveform



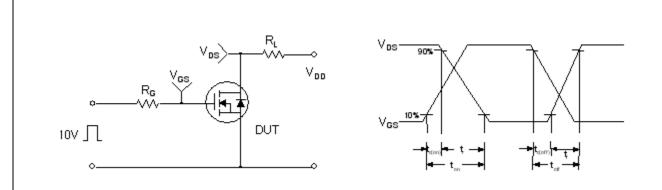
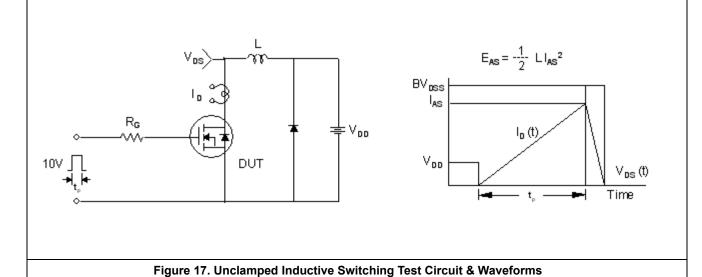
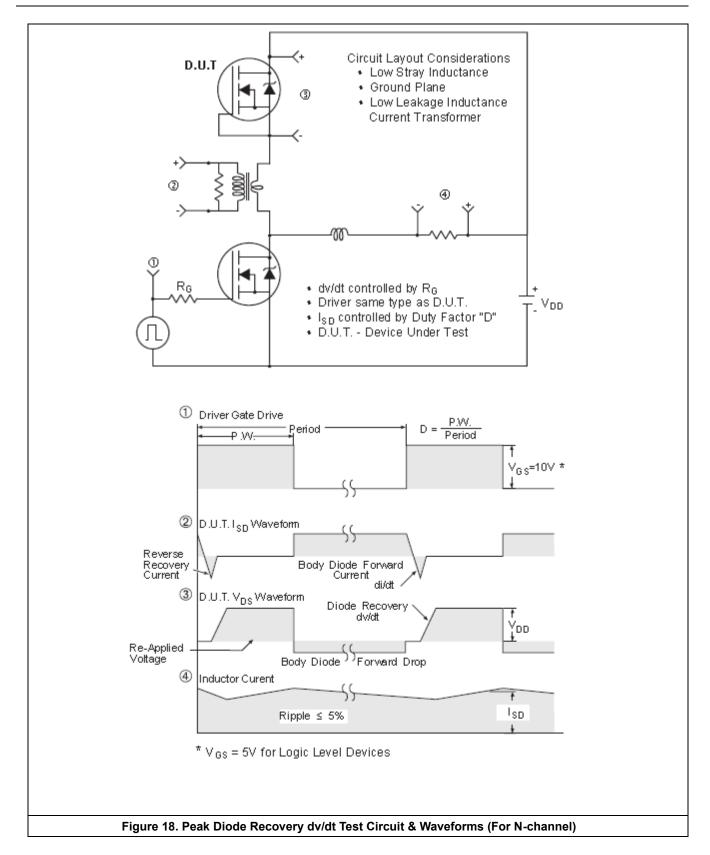


Figure 16. Resistive Switching Test Circuit & Waveforms

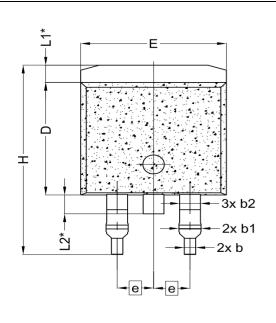


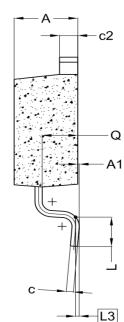


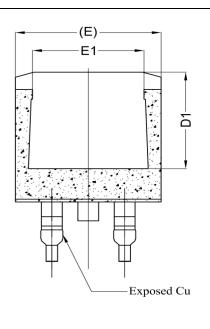




Package outline







SYMBOL	DIMENSIONS				
STIMBOL	MIN.	NOM.	MAX.		
А	4.24	4.44	4.64		
A1	0.00	0.10	0.25		
b	0.70	0.80	0.90		
b1	1.20	1.55	1.75		
b2	1.20	1.45	1.70		
С	0.40	0.50	0.60		
c2	1.15	1.27	1.40		
D	8.82	8.92	9.02		
D1	6.86	7.65			
E	9.96	10.16	10.36		
E1	6.89	7.77	7.89		
е	2.54 BSC				
Н	14.61	15.00	15.88		
L	1.78	2.32	2.79		
L1	1.36 REF.				
L2	1.50 REF.				
L3	0.25 BSC				
Q	2.30 2.48 2.70				

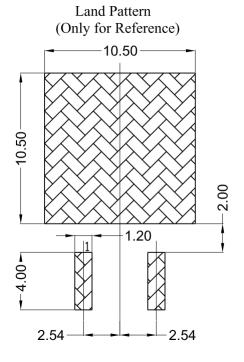


Figure 19. TO263-3L Package outline



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